

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
TOHOKU TECHNO ARCH CO., LTD.	05/26/2016
RECEIVING PARTY DATA	
Name:	TOHOKU MAGNET INSTITUTE CO., LTD.
Street Address:	4F MATERIAL SOLUTIONS CENTER,
Internal Address:	2-1-1 KATAHIRA,
City:	AOBA-KU, SENDAI-SHI, MIYAGI
State/Country:	JAPAN
Postal Code:	980-0812
PROPERTY NUMBERS Total: 1	
Property Type	Number
Patent Number:	8277579
CORRESPONDENCE DATA	
Fax Number:	(212)319-5101
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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NAME OF SUBMITTER:	DAWN MCCOY
SIGNATURE:	/Dawn McCoy/
DATE SIGNED:	06/16/2016
Total Attachments: 1	
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ASSIGNMENT

Whereas **TOHOKU TECHNO ARCH CO., LTD.** (referred to hereinafter as the "Assignor"), a corporation organized under the laws of Japan and having a place of business 468, Aza Aoba, Aramaki, Aoba-ku, Sendai-shi, Miyagi 980-0845 Japan, is the owner of the entire right, title and interest in and to U.S. Patent No. 8,277,579 (referred to hereinafter as said "U.S. Patent") and the invention described and claimed therein, by virtue of an Assignment recorded in the USPTO on July 13, 2009 at Reel 022948, Frame 0640;

Whereas **TOHOKU MAGNET INSTITUTE CO., LTD** (referred to hereinafter as the "Assignee"), a corporation organized under the laws of Japan and having a place of business at 4F Material Solutions Center, 2-1-1 Katahira, Aoba-ku, Sendai-shi, Miyagi 980-0812, Japan, is desirous of acquiring the entire right, title and interest of the Assignor to said U.S. Patent and said invention;

For good and valuable consideration, the receipt of which is hereby acknowledged, the Assignor hereby sells, assigns, transfers and sets over to said Assignee and its successors, assigns or other legal representatives, the Assignor's entire right, title and interest in and to said U.S. Patent and said invention, including all divisions, continuations, reissues and reexaminations thereof, the same to be held and enjoyed by said Assignee, for its own use and enjoyment and the use and enjoyment of its successors, assigns or other legal representatives;

The Assignor has caused the signature of the undersigned, who is authorized to sign on behalf of the Assignor, to be subscribed hereto on the date set forth below.

Assignor: **TOHOKU TECHNO ARCH CO., LTD.**

By: 

Name: Takanobu MIZUTA
Corporate Title: President

Date: May 26, 2016